



| | | | |
|---|------------------------|--------------------------|------------------|
| Form SB08 | | Complete if Known | |
| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (use as many sheets as necessary) | | Application Number | 10/691,644 |
| | | Filing Date | October 24, 2003 |
| | | First Named Inventor | Min-Goo KIM |
| | | Art Unit | 2138 |
| | | Examiner Name | Steve N. Nguyen |
| Sheet 1 of 1 | Attorney Docket Number | 45945 | |

| U.S. PATENT DOCUMENTS | | | | | |
|-----------------------|-------------|-----------------------------|--------------------------------|--|--|
| Examiner Initials | Cite No. | Document Number | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
| | | Number-Kind Code (if known) | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |
| | | US- | | | |

| FOREIGN PATENT DOCUMENTS | | | | | | |
|--------------------------|-------------|--|--------------------------------|---|--|---|
| Examiner Initials | Cite No. | Foreign Patent Document | Publication Date MM-DD-YYYY | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear | T |
| | | Country Code-Number- Kind Code (if known) | | | | |
| | 1. | JP 2001-358699 | 12-26-2001 | Seidel EIKO et al. | | X |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |
| | | | | | | |

| NON PATENT LITERATURE DOCUMENTS | | | | | | |
|---------------------------------|-------------|---|--|--|--|---|
| Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publishers, city and/or country where published | | | | T |
| | | | | | | |
| | 2. | LG Electronics, "Updated Joint Physical Layer Proposal for 1xEV-DV," 3GPP2-C50-20010326-025; Seattle, WA; March 29, 2001 | | | | |
| | 3. | MIN-GOO KIM, "Enhanced Throughput with Hybrid ARQ Samsung 1xEV-DV Proposal - Hybrid ARQ Solutions Toward Advanced Platform for High Data Rate Evolution (HAPRE)," 3GPP2-C50-2001204-017, Kanai, USA; December 4, 2000 | | | | |

| | | | |
|-----------------------|----------------|--------------------|------------|
| Examiner Signature | /Steve Nguyen/ | Date Considered | 05/05/2009 |
|-----------------------|----------------|--------------------|------------|